

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Arnon Lewartowski</td> <td>04/15/2012</td> </tr> <tr> <td>Yaakov Levi</td> <td>04/15/2012</td> </tr> <tr> <td>Rom Condrea</td> <td>04/15/2012</td> </tr> </tbody> </table>		Name	Execution Date	Arnon Lewartowski	04/15/2012	Yaakov Levi	04/15/2012	Rom Condrea	04/15/2012		
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>DIP-TECH LTD</td> </tr> <tr> <td>Street Address:</td> <td>5 Atir Yeda Street</td> </tr> <tr> <td>City:</td> <td>Kefar Sava</td> </tr> <tr> <td>State/Country:</td> <td>ISRAEL</td> </tr> <tr> <td>Postal Code:</td> <td>44543</td> </tr> </table>		Name:	DIP-TECH LTD	Street Address:	5 Atir Yeda Street	City:	Kefar Sava	State/Country:	ISRAEL	Postal Code:	44543
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PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13773074</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13773074						
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CORRESPONDENCE DATA											
<p>Fax Number: 7708040900 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 770-709-0080 Email: gsmith@srtslaw.com Correspondent Name: SMITH RISLEY TEMPEL SANTOS LLC Address Line 1: Two Ravinia Drive Address Line 2: Suite 700 Address Line 4: ATLANTA, GEORGIA 30346</p>											
ATTORNEY DOCKET NUMBER:	04042.1020										
NAME OF SUBMITTER:	Gregory Scott Smith										
<p>Total Attachments: 6 source=ASSIGNMENT OF PATENT APPLICATION 157-005-USP-signed#page1.tif</p>											

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ASSIGNMENT OF PATENT APPLICATION

I/We, the undersigned (each) have agreed and hereby agree to assign to DIP-TECH LTD., a Company registered in the State of Israel and having its principal place of business at 5 Atir Yeda Street, Kefar Sava 44543 Israel in furtherance of my/our obligations to the Dip-Tech Ltd., and its subsidiaries and affiliates, and do hereby assign and transfer to Dip-Tech Ltd., it's successors and assigns the entire right title and interest, including the right of priority, in, to and under an application for Letters Patent of the United States entitled:

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Filing Date: February 21, 2012 Application No.: 61/601,209

and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part (CIPs), divisional, and renewals of and substitutes for said application for said Letters Patent, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefore: and any reissues, or reexaminations, or extensions of said Letters Patent.

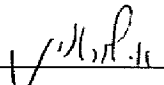
I/We additionally authorize Dip-Tech Ltd., to file applications, in my/our name for Letter Patent in any country, to be held and enjoyed by Dip-Tech Ltd., it's successors, assigns, nominees or legal representatives to the full end of the term or terms for which said Letters Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made;

AND I/we hereby covenant that I/We have full right to convey the entire interest herein assigned and that I/We have not executed and will not execute any agreement in conflict herewith, and I/We further covenant and agree that I/We will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said

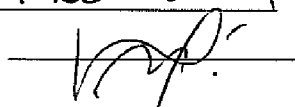

application and said Letters Patent to Dip-Tech Ltd., its successors, assigns, nominees or legal representatives, and I/We agree to communicate to Dip-Tech Ltd., or to its nominee, all known facts respecting said invention(s) or improvement(s), said application and said Letters Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisional, continuations, CIPs, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything possible to aid Dip-Tech Ltd., its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvement(s) and any and all countries provided the expenses which may be incurred by me/us in lending such cooperation and as assistance are paid by Dip-Tech Ltd.,

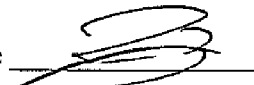
AND I/We hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any country or countries foreign to the United States whose duty it is to issue patents applications as aforesaid, to issue to Dip-Tech Ltd., as assignee of the entire right, title and interest, any and all Letters Patent for said invention(s) or improvement(s), including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this assignment.

I/We further authorize and direct the attorneys of record to insert the serial number and filing date of said application now identified by the Record ID and title set forth above as soon as the same shall have been made known to them by the United States Patent and Trademark Office.

Inventor's Signature 
Inventor's Name LEWARTOWSKI, Aron


Signed April 15 2012

Witness name ARIEL LEWARTOWSKI
Witness signature 
Witness name ZIR LUK
Witness signature 

Inventor's Signature 
Inventor's Name: LEVI, Yaakov

Signed April 18, 2012

Witness name ANIEL LITWAK

Witness signature 

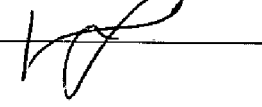
Witness name ZIV LUK

Witness signature 

Inventor's Signature 
Inventor's Name: CONDREA, Rom

Signed April 15, 2012

Witness name ANIEL LITWAK

Witness signature 

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Witness signature 

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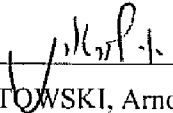
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Inventor's Name LEWARTOWSKI, Arnon

Witness name ARIEL LITWAK

Witness signature 

Witness name ZIV LUK


Witness signature 

Inventor's Signature 


Signed April 15, 2012

Inventor's Name: LEVI, Yaakov

Witness name AMIEL LITWAK

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Witness name ZIV LUK

Witness signature 

Inventor's Signature Rom Condrea

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